# Octal Buffer/Line Driver with 3-State Outputs

The MC74AC540/74ACT540 and MC74AC541/74ACT541 are octal buffer/line drivers designed to be employed as memory and address drivers, clock drivers and bus oriented transmitter/receivers. The MC74AC541/74ACT541 is a noninverting option of the MC74AC540/74ACT540.

These devices are similar in function to the MC74AC240/74ACT240 and MC74AC244/74ACT244 while providing flow–through architecture (inputs on opposite side from outputs). This pinout arrangement makes these devices especially useful as output ports for microprocessors, allowing ease of layout and greater PC board density.

# **Features**

- 3-State Outputs
- Inputs and Outputs Opposite Side of Package, Allowing Easier Interface to Microprocessors
- Outputs Source/Sink 24 mA
- MC74AC540/74ACT540 Provides Inverted Outputs
- MC74AC541/74ACT541 Provides Noninverted Outputs
- 'ACT540 and 'ACT541 Have TTL Compatible Inputs
- These are Pb-Free Devices

# **TRUTH TABLE**

	Inputs		Out	puts
ŌE <sub>1</sub>	OE <sub>2</sub>	D	<b>′</b> 540	′541
L H X L	L X H L	H X X L	L Z Z H	H Z Z L

H = HIGH Voltage Level

L = LOW Voltage Level

X = Immaterial

Z = High Impedance



ON Semiconductor®

www.onsemi.com



SOIC-20W DW SUFFIX CASE 751D



TSSOP-20 DT SUFFIX CASE 948E

## ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 8 of this data sheet.

### **DEVICE MARKING INFORMATION**

See general marking information in the device marking section on page 8 of this data sheet.

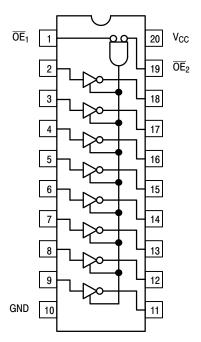


Figure 1. MC74AC540/74ACT540

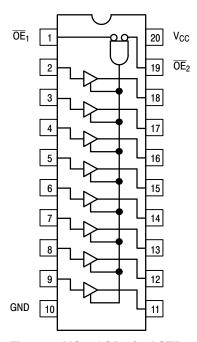


Figure 2. MC74AC541/74ACT541

#### **MAXIMUM RATINGS**

Symbol	Parameter		Value	Unit
V <sub>CC</sub>	DC Supply Voltage (Referenced to GND)		-0.5 to +7.0	V
V <sub>IN</sub>	DC Input Voltage (Referenced to GND)		–0.5 to V <sub>CC</sub> +0.5	V
V <sub>OUT</sub>	DC Output Voltage (Referenced to GND) (Note 1)		-0.5 to V <sub>CC</sub> +0.5	V
I <sub>IK</sub>	DC Input Diode Current		±20	mA
I <sub>OK</sub>	DC Output Diode Current		±50	mA
I <sub>OUT</sub>	DC Output Sink/Source Current		±50	mA
I <sub>CC</sub>	DC Supply Current, per Output Pin		±50	mA
I <sub>GND</sub>	DC Ground Current, per Output Pin		±100	mA
T <sub>STG</sub>	Storage Temperature Range		-65  to  +150	°C
TL	Lead temperature, 1 mm from Case for 10 Seconds		260	°C
$T_J$	Junction Temperature Under Bias		140	°C
$\theta_{JA}$	Thermal Resistance (Note 2)	SOIC TSSOP	65.8 110.7	°C/W
MSL	Moisture Sensitivity		Level 1	
F <sub>R</sub>	Flammability Rating Oxygen Index	k: 30% – 35%	UL 94 V-0 @ 0.125 in	
V <sub>ESD</sub>	ESD Withstand Voltage  Human Body M  Machine M  Charged Device M	lodel (Note 4)	> 2000 > 200 > 1000	V
I <sub>Latchup</sub>	Latchup Performance Above V <sub>CC</sub> and Below GND at 8	35°C (Note 6)	±100	mA

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- 1. I<sub>OUT</sub> absolute maximum rating must be observed.
- The package thermal impedance is calculated in accordance with JESD 51–7.
- 3. Tested to EIA/JESD22-A114-A.
- 4. Tested to EIA/JESD22-A115-A.
- Tested to JESD22-C101-A.
- 6. Tested to EIA/JESD78.

#### RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Parameter		Тур	Max	Unit	
\/	Complex Voltage	'AC	2.0	5.0	6.0		
V <sub>CC</sub>	Supply Voltage	'ACT	4.5	5.0	5.5	V	
V <sub>IN</sub> , V <sub>OUT</sub>	DC Input Voltage, Output Voltage (Ref. to GND)		0	_	V <sub>CC</sub>	V	
		V <sub>CC</sub> @ 3.0 V	-	150	_		
t <sub>r</sub> , t <sub>f</sub>	Input Rise and Fall Time (Note 1)  'AC Devices except Schmitt Inputs	V <sub>CC</sub> @ 4.5 V	-	40	_	ns/V	
	The Devices except estimat inputs	V <sub>CC</sub> @ 5.5 V	-	25	_		
	Input Rise and Fall Time (Note 2)	V <sub>CC</sub> @ 4.5 V	-	10	_		
t <sub>r</sub> , t <sub>f</sub>	'ACT Devices except Schmitt Inputs V <sub>CC</sub> @ 5.5 V		-	8.0	_	ns/V	
T <sub>A</sub>	Operating Ambient Temperature Range	-40	25	85	°C		
I <sub>OH</sub>	Output Current – High			-	-24	mA	
I <sub>OL</sub>	Output Current – Low		-	_	24	mA	

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

1. V<sub>IN</sub> from 30% to 70% V<sub>CC</sub>; see individual Data Sheets for devices that differ from the typical input rise and fall times.

2. V<sub>IN</sub> from 0.8 V to 2.0 V; see individual Data Sheets for devices that differ from the typical input rise and fall times.

# **DC CHARACTERISTICS**

			74	AC	74AC		
	Parameter	Vcc	T <sub>A</sub> = +25°C		T <sub>A</sub> = -40°C to +85°C		
Symbol		(V)	Тур	Gu	aranteed Limits	Unit	Conditions
V <sub>IH</sub>	Minimum High Level	3.0	1.5	2.1	2.1		V <sub>OUT</sub> = 0.1 V
	Input Voltage	4.5	2.25	3.15	3.15	V	or V <sub>CC</sub> – 0.1 V
		5.5	2.75	3.85	3.85		
$V_{IL}$	Maximum Low Level	3.0	1.5	0.9	0.9		V <sub>OUT</sub> = 0.1 V
	Input Voltage	4.5	2.25	1.35	1.35	V	or V <sub>CC</sub> – 0.1 V
		5.5	2.75	1.65	1.65		
V <sub>OH</sub>	Minimum High Level	3.0	2.99	2.9	2.9		I <sub>OUT</sub> = -50 μA
	Output Voltage	4.5	4.49	4.4	4.4	V	
		5.5	5.49	5.4	5.4		
							*V <sub>IN</sub> = V <sub>IL</sub> or V <sub>IH</sub>
		3.0	_	2.56	2.46	.,	-12 mA
		4.5	_	3.86	3.76	V	I <sub>OH</sub> –24 mA
		5.5	_	4.86	4.76		–24 mA
V <sub>OL</sub>	Maximum Low Level	3.0	0.002	0.1	0.1		I <sub>OUT</sub> = 50 μA
	Output Voltage	4.5	0.001	0.1	0.1	V	
		5.5	0.001	0.1	0.1		
							*V <sub>IN</sub> = V <sub>IL</sub> or V <sub>IH</sub>
		3.0	_	0.36	0.44	.,	12 mA
		4.5	_	0.36	0.44	V	I <sub>OL</sub> 24 mA
		5.5	-	0.36	0.44		24 mA
I <sub>IN</sub>	Maximum Input	5.5		±0.1	±1.0		V – V CND
	Leakage Current	5.5	_	±0.1	±1.U	μΑ	$V_I = V_{CC}$ , GND
loz	Maximum						$V_{I}(OE) = V_{IL}, V_{IH}$
-	3-State	5.5	_	±0.5	±5.0	μΑ	$V_I = V_{CC}$ , GND
	Current					•	$V_O = V_{CC}$ , GND
I <sub>OLD</sub>	†Minimum Dynamic	5.5	_	_	75	mA	V <sub>OLD</sub> = 1.65 V Max
	Output Current	5.5			-		
I <sub>OHD</sub>		5.5	_	_	<b>-75</b>	mA	V <sub>OHD</sub> = 3.85 V Min
$I_{CC}$	Maximum Quiescent	5.5	_	8.0	80	μΑ	$V_{IN} = V_{CC}$ or GND
	Supply Current	5.5		0.0		p	- IIV - CC 5. 511B

<sup>\*</sup>All outputs loaded; thresholds on input associated with output under test. †Maximum test duration 2.0 ms, one output loaded at a time.

NOTE:  $I_{IN}$  and  $I_{CC}$  @ 3.0 V are guaranteed to be less than or equal to the respective limit @ 5.5 V  $V_{CC}$ .

AC CHARACTERISTICS (For Figures and Waveforms – See AND8277/D at www.onsemi.com)

				74AC		74	AC		
		V <sub>CC</sub> *		T <sub>A</sub> = +25°C C <sub>L</sub> = 50 pF		T <sub>A</sub> = -40°C to +85°C C <sub>L</sub> = 50 pF			Fig.
Symbol	Parameter	(V)	Min	Тур	Max	Min	Max	Unit	No.
t <sub>PLH</sub>	Propagation Delay Data to Output ('AC540)	3.3 5.0	1.5 1.5	5.5 4.0	7.5 6.0	1.0 1.0	8.0 6.5	ns	3–5
t <sub>PHL</sub>	Propagation Delay Data to Output ('AC540)	3.3 5.0	1.5 1.5	5.0 4.0	7.0 5.5	1.0 1.0	7.5 6.0	ns	3–5
t <sub>PZH</sub>	Output Enable Time ('AC540)	3.3 5.0	3.0 2.0	8.5 6.5	11 8.5	2.5 2.0	12 9.5	ns	3–7
t <sub>PZL</sub>	Output Enable Time ('AC540)	3.3 5.0	2.5 2.0	7.5 6.0	10 7.5	2.0 1.5	11 8.5	ns	3–8
t <sub>PHZ</sub>	Output Disable Time ('AC540)	3.3 5.0	2.5 1.5	8.5 7.5	13 10.5	1.5 1.0	14 11	ns	3–7
$t_{PLZ}$	Output Disable Time ('AC540)	3.3 5.0	2.0 1.5	7.0 6.0	10 8.0	2.0 1.5	11 9.0	ns	3–8
t <sub>PLH</sub>	Propagation Delay Data to Output ('AC541)	3.3 5.0	2.0 1.5	5.5 4.0	8.0 6.0	1.5 1.0	9.0 6.5	ns	3–5
t <sub>PHL</sub>	Propagation Delay Data to Output ('AC541)	3.3 5.0	2.0 1.5	5.5 4.0	8.0 6.0	1.5 1.0	8.5 6.5	ns	3–5
t <sub>PZH</sub>	Output Enable Time ('AC541)	3.3 5.0	3.0 2.0	8.0 6.0	11.5 8.5	3.0 1.5	12.5 9.5	ns	3–7
t <sub>PZL</sub>	Output Enable Time ('AC541)	3.3 5.0	2.5 1.5	7.0 5.5	10 7.5	2.5 1.0	11.5 8.5	ns	3–8
t <sub>PHZ</sub>	Output Disable Time ('AC541)	3.3 5.0	3.5 2.0	9.0 7.0	12.5 9.5	2.5 1.0	14 10.5	ns	3–7
t <sub>PLZ</sub>	Output Disable Time ('AC541)	3.3 5.0	2.5 2.0	6.5 5.5	9.5 7.5	2.0 1.0	10.5 8.5	ns	3–8

<sup>\*</sup>Voltage Range 3.3 V is 3.3 V  $\pm 0.3$  V. Voltage Range 5.0 V is 5.0 V  $\pm 0.5$  V.

# **DC CHARACTERISTICS**

			74 <i>A</i>	СТ	74ACT		
		v <sub>cc</sub>	T <sub>A</sub> = -	+25°C	T <sub>A</sub> = -40°C to +85°C		
Symbol	Parameter	(V)	Тур	Gu	aranteed Limits	Unit	Conditions
V <sub>IH</sub>	Minimum High Level Input Voltage	4.5 5.5	1.5 1.5	2.0 2.0	2.0 2.0	٧	V <sub>OUT</sub> = 0.1 V or V <sub>CC</sub> – 0.1 V
V <sub>IL</sub>	Maximum Low Level Input Voltage	4.5 5.5	1.5 1.5	0.8 0.8	0.8 0.8	٧	V <sub>OUT</sub> = 0.1 V or V <sub>CC</sub> – 0.1 V
V <sub>OH</sub>	Minimum High Level Output Voltage	4.5 5.5	4.49 5.49	4.4 5.4	4.4 5.4	٧	I <sub>OUT</sub> = -50 μA
		4.5 5.5	- -	3.86 4.86	3.76 4.76	V	$^*V_{IN} = V_{IL} \text{ or } V_{IH}$ $I_{OH} -24 \text{ mA}$ $-24 \text{ mA}$
V <sub>OL</sub>	Maximum Low Level Output Voltage	4.5 5.5	0.001 0.001	0.1 0.1	0.1 0.1	٧	I <sub>OUT</sub> = 50 μA
		4.5 5.5	- -	0.36 0.36	0.44 0.44	V	$^*V_{IN} = V_{IL} \text{ or } V_{IH}$ $^{24} \text{ mA}$ $^{1}OL$ $^{24} \text{ mA}$
I <sub>IN</sub>	Maximum Input Leakage Current	5.5	-	±0.1	±1.0	μΑ	$V_I = V_{CC}$ , GND
$\Delta I_{CCT}$	Additional Max. I <sub>CC</sub> /Input	5.5	0.6	-	1.5	mA	$V_{I} = V_{CC} - 2.1 \text{ V}$
I <sub>OZ</sub>	Maximum 3-State Current	5.5	-	±0.5	±5.0	μΑ	$V_{I}$ (OE) = $V_{IL}$ , $V_{IH}$ $V_{I}$ = $V_{CC}$ , GND $V_{O}$ = $V_{CC}$ , GND
I <sub>OLD</sub>			-	-	75	mA	V <sub>OLD</sub> = 1.65 V Max
I <sub>OHD</sub>	Output Current	5.5	-	-	<b>-</b> 75	mA	V <sub>OHD</sub> = 3.85 V Min
Icc	Maximum Quiescent Supply Current	5.5	_	8.0	80	μΑ	V <sub>IN</sub> = V <sub>CC</sub> or GND

<sup>\*</sup>All outputs loaded; thresholds on input associated with output under test. †Maximum test duration 2.0 ms, one output loaded at a time.

AC CHARACTERISTICS (For Figures and Waveforms – See AND8277/D at www.onsemi.com)

				74ACT		74	CT		
Symbol	Parameter	V <sub>CC</sub> * (V)	T <sub>A</sub> = +25°C C <sub>L</sub> = 50 pF			$T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}$ $C_L = 50 \text{ pF}$		Unit	Fig. No.
			Min	Тур	Max	Min	Max		
t <sub>PLH</sub>	Propagation Delay Data to Output ('ACT540)	5.0	1.0	_	7.0	1.0	7.5	ns	3–5
t <sub>PHL</sub>	Propagation Delay Data to Output ('ACT540)	5.0	1.0	-	8.0	1.0	8.5	ns	3–5
t <sub>PZH</sub>	Output Enable Time ('ACT540)	5.0	1.0		10.5	1.0	11.5	ns	3–7
t <sub>PZL</sub>	Output Enable Time ('ACT540)	5.0	1.0	_	9.5	1.0	10.5	ns	3–8
t <sub>PHZ</sub>	Output Disable Time ('ACT540)	5.0	1.0	-	12.0	1.0	12.5	ns	3–7
t <sub>PLZ</sub>	Output Disable Time ('ACT540)	5.0	1.5	-	9.0	1.0	10	ns	3–8
t <sub>PLH</sub>	Propagation Delay Data to Output ('ACT541)	5.0	1.5	-	7.5	1.0	8.0	ns	3–5
t <sub>PHL</sub>	Propagation Delay Data to Output ('ACT541)	5.0	1.5	-	7.5	1.0	8.0	ns	3–5
t <sub>PZH</sub>	Output Enable Time ('ACT541)	5.0	2.0	_	10.0	1.0	11.0	ns	3–7
t <sub>PZL</sub>	Output Enable Time ('ACT541)	5.0	1.5	_	9.5	1.0	10.5	ns	3–8
t <sub>PHZ</sub>	Output Disable Time ('ACT541)	5.0	2.0	-	11.0	1.0	12.0	ns	3–7
t <sub>PLZ</sub>	Output Disable Time ('ACT541)	5.0	2.0	-	9.0	1.0	10	ns	3–8

<sup>\*</sup>Voltage Range 5.0 V is 5.0 V  $\pm$ 0.5 V.

# **CAPACITANCE**

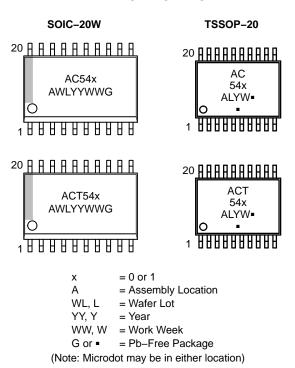
Symbol	Symbol Parameter		Unit	Test Conditions
C <sub>IN</sub> Input Capacitance		4.5	pF	$V_{CC} = 5.0 \text{ V}$
C <sub>PD</sub>	C <sub>PD</sub> Power Dissipation Capacitance		pF	V <sub>CC</sub> = 5.0 V

#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
MC74AC540DWG	SOIC-20 (Pb-Free)	38 Units / Rail
MC74AC540DWR2G	SOIC-20 (Pb-Free)	1000 / Tape & Reel
MC74ACT540DWG	SOIC-20 (Pb-Free)	38 Units / Rail
MC74ACT540DWR2G	SOIC-20 (Pb-Free)	1000 / Tape & Reel
MC74ACT540DTR2G	TSSOP-20 (Pb-Free)	2500 / Tape & Reel
MC74AC541DWG	SOIC-20 (Pb-Free)	38 Units / Rail
MC74AC541DWR2G	SOIC-20 (Pb-Free)	1000 / Tape & Reel
MC74ACT541DWG	SOIC-20 (Pb-Free)	38 Units / Rail
MC74ACT541DWR2G	SOIC-20 (Pb-Free)	1000 / Tape & Reel
MC74AC541DTR2G	TSSOP-20 (Pb-Free)	2500 / Tape & Reel
MC74ACT541DTG	TSSOP-20 (Pb-Free)	75 Units / Rail
MC74ACT541DTR2G	TSSOP-20 (Pb-Free)	2500 / Tape & Reel

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

# **MARKING DIAGRAMS**



<sup>\*</sup>These packages are inherently Pb-Free.

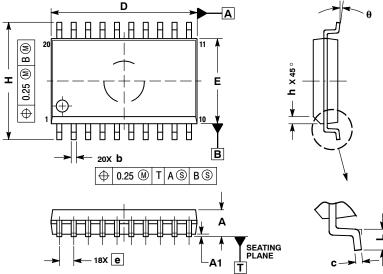




SOIC-20 WB CASE 751D-05 **ISSUE H** 

**DATE 22 APR 2015** 

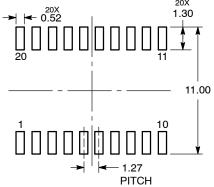
# SCALE 1:1



- DIMENSIONS ARE IN MILLIMETERS.
   INTERPRET DIMENSIONS AND TOLERANCES.
- PER ASME Y14.5M, 1994.
  3. DIMENSIONS D AND E DO NOT INCLUDE MOLD
- PROTRUSION.
  MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.
- DIMENSION B DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE PROTRUSION SHALL BE 0.13 TOTAL IN EXCESS OF B DIMENSION AT MAXIMUM MATERIAL

	MILLIMETERS						
DIM	MIN	MAX					
Α	2.35	2.65					
A1	0.10	0.25					
b	0.35	0.49					
С	0.23	0.32					
D	12.65	12.95					
E	7.40	7.60					
е	1.27	BSC					
Н	10.05	10.55					
h	0.25	0.75					
L	0.50	0.90					
A	0 °	7 °					

# **RECOMMENDED SOLDERING FOOTPRINT\***



DIMENSIONS: MILLIMETERS

# **GENERIC MARKING DIAGRAM\***



XXXXX = Specific Device Code = Assembly Location

WL = Wafer Lot ΥY = Year WW = Work Week = Pb-Free Package

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present.

	DOCUMENT NUMBER:	98ASB42343B	Electronic versions are uncontrolled except when accessed directly from Printed versions are uncontrolled except when stamped "CONTROLLED (	
I	DESCRIPTION:	SOIC-20 WB		PAGE 1 OF 1

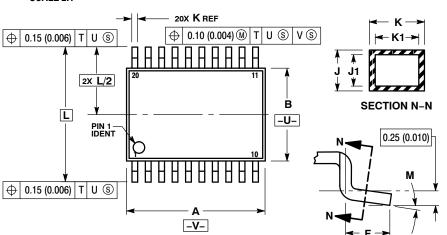
ON Semiconductor and unare trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights of others.

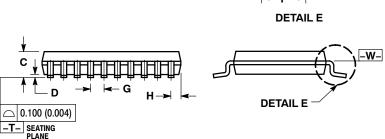
<sup>\*</sup>For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.



# TSSOP-20 WB CASE 948E ISSUE D

**DATE 17 FEB 2016** 





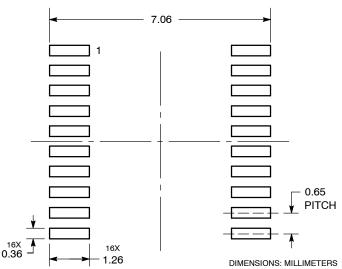
#### NOTES:

- DIMENSIONING AND TOLERANCING PER
- ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: MILLIMETER.
- 3. DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.
- FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE. DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K
- (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.
- TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.

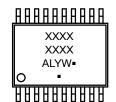
  7. DIMENSION A AND B ARE TO BE
- DETERMINED AT DATUM PLANE -W-

	MILLIN	IETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
Α	6.40	6.60	0.252	0.260
В	4.30	4.50	0.169	0.177
С		1.20		0.047
D	0.05	0.15	0.002	0.006
F	0.50	0.75	0.020	0.030
G	0.65	BSC	0.026 BSC	
Н	0.27	0.37	0.011	0.015
J	0.09	0.20	0.004	0.008
J1	0.09	0.16	0.004	0.006
K	0.19	0.30	0.007	0.012
K1	0.19	0.25	0.007	0.010
L	6.40	6.40 BSC		BSC
M	0°	8°	0°	8°

## **SOLDERING FOOTPRINT**



# **GENERIC MARKING DIAGRAM\***



= Assembly Location

= Wafer Lot

= Year

= Work Week

= Pb-Free Package

(Note: Microdot may be in either location)

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present.

DOCUMENT NUMBER:	98ASH70169A	Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.	
DESCRIPTION:	TSSOP-20 WB		PAGE 1 OF 1

ON Semiconductor and un are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights of others.

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at <a href="www.onsemi.com/site/pdf/Patent-Marking.pdf">www.onsemi.com/site/pdf/Patent-Marking.pdf</a>. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does **onsemi** assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using **onsemi** products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by **onsemi**. "Typical" parameters which may be provided in **onsemi** data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. **onsemi** does not convey any license under any of its intellectual property rights nor the rights of others. **onsemi** products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use **onsemi** products for any such unintended or unauthorized application, Buyer shall indemnify and hold **onsemi** and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that **onsemi** was negligent regarding the design or manufacture of the part. **onsemi** is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

#### PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT: Email Requests to: orderlit@onsemi.com

onsemi Website: www.onsemi.com

**TECHNICAL SUPPORT** North American Technical Support: Voice Mail: 1 800–282–9855 Toll Free USA/Canada

Phone: 011 421 33 790 2910

Europe, Middle East and Africa Technical Support:

Phone: 00421 33 790 2910

For additional information, please contact your local Sales Representative